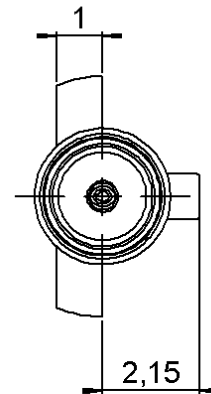
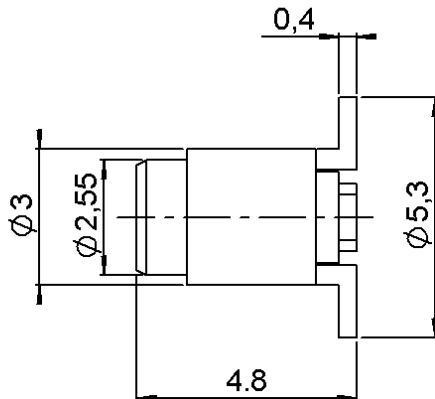


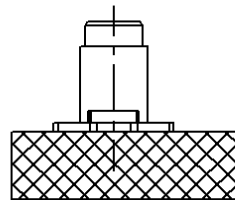
SMT RECEPTACLE FOR PCB

R199.005.523

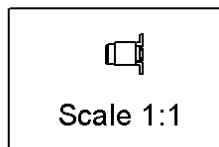
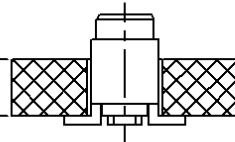
Series : MC-CARD



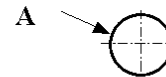
Montage en surface



Montage par l'arrière

 5.5 max pour un accouplement
avec fiche coudée


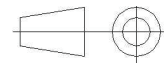
PANEL CUT OUT



	mm	
	Maxi	mini
A	3.40	3.20

Uniquement pour montage arrière

All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (μm)
BODY	BRASS	GOLD 0.5 OVER NICKEL 2
CENTER CONTACT	BERYLLIUM COPPER	GOLD 1.3 OVER NICKEL 2
OUTER CONTACT	BRASS	GOLD 0.5 OVER NICKEL 2
INSULATOR	PTFE	
GASKET		
OTHERS PARTS		
-	-	-
-	-	-

Issue : 0430 D

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



SMT RECEPTACLE FOR PCB

R199.005.523

Series : MC-CARD

PACKAGING

Standard	Unit	Other
1	-	Contact us

SPECIFICATION**917 686 82****ELECTRICAL CHARACTERISTICS**

Impedance	50	Ω
Frequency	0-8	GHz
VSWR	1.15 + 0.015	x F(GHz) Maxi
Insertion loss	.07	$\sqrt{F}(\text{GHz})$ dB Maxi
RF leakage	- (	- F(GHz)) dB Maxi
Voltage rating	170	Veff Maxi
Dielectric withstanding voltage	500	Veff mini
Insulation resistance	5000	M Ω mini

ENVIRONMENTAL

Operating temperature	-65/+165	$^{\circ}\text{C}$
Hermetic seal	NA	Atm.cm3/s
Panel leakage	NA	

OTHERS CHARACTERISTICS

Assembly instruction

Others :

MECHANICAL CHARACTERISTICS

Center contact retention	
Axial force – Mating end	NA N mini
Axial force – Opposite end	NA N mini
Torque	NA N.cm mini
Recommended torque	
Mating	NA N.cm
Panel nut	NA N.cm
Mating life	500 Cycles mini
Weight	0.153 g

Issue : 0430 D

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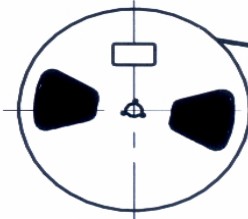
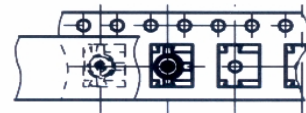
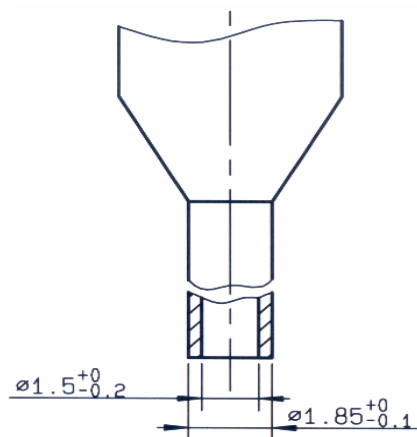
SMT RECEPTACLE FOR PCB

R199.005.523

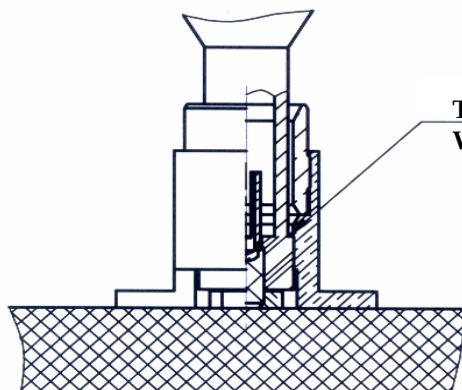
Series : MC-CARD

MC-CARD SERIES - INFORMATION

R199.005.820
Ou
R199.005.821

**ASPIRATION PORT****ALVEOLES**

TRANSLATION OF THE RECEPTACLE
FROM THE REEL TO THE PCB



THE ASPIRATION PORT SHOULD BE IN CONTACT
WITH THE INSULATOR

CI

PCB

Issue : 0430 D

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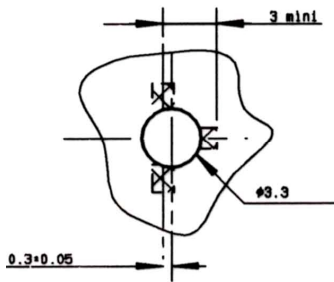
SMT RECEPTACLE FOR PCB

R199.005.523

Series : MC-CARD

MC-CARD SERIES - INFORMATIONS

Solution A



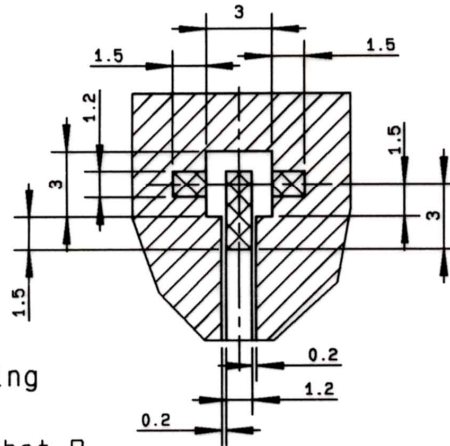
receptacle back planting

Same printed circuit that B
+ DIA 0.13

Solution A



Solution B



Solution B



Pattern

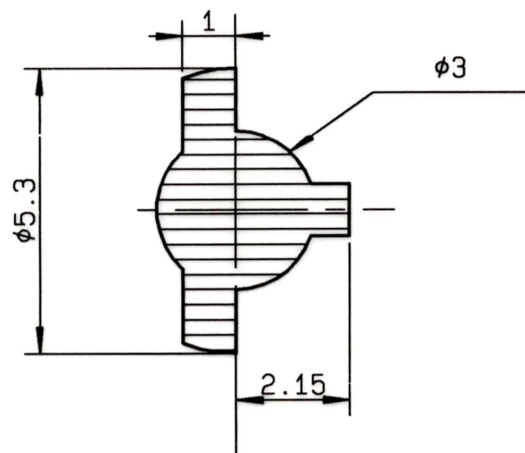


Land for solder paste

COPLANAR LINE

Pattern and signal are on the same side
Thickness of PCB : .063 (1.6 mm)
The material of PCB is the epoxy resin
of glass fabrics bags. (Er = 4.8)
The solder resist should be printed
except for the land pattern on the PCB.

**SHADOW OF MC-CARD RECEPTACLE
FOR VIDEO CAMERA**



Issue : 0430 D

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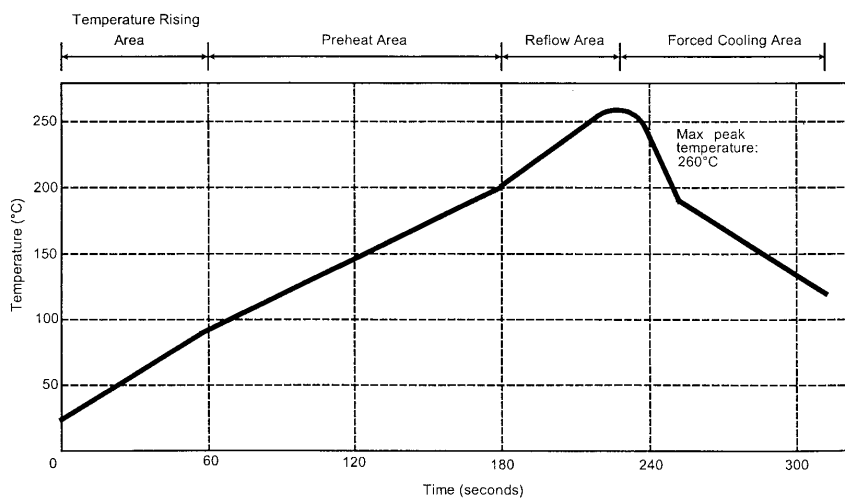


SMT RECEPTACLE FOR PCB**R199.005.523**

Series : MC-CARD

SOLDER PROCEDURE

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application.
We recommend a low residue flux.
We advise a thickness of 200 microns. Verify that the edges of the zone are clean.
2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
3. Soldering by infra-red reflow.
Below, please find the typical profile to use.
4. Cleaning of printed circuit boards.
5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE

Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

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